



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-------------------|
| Chip Size | 1812 |
| L | 4.7mm +0.3/-0.2mm |
| W | 3.3mm +/-0.3mm |
| T | 1.7mm MAX |
| B | 0.4mm +0.5/-0.3mm |

Packaging Specifications

| | |
|--------------------|------|
| Packaging | T&R |
| Packaging Quantity | 4000 |

General Information

| | |
|------------------|------------------------|
| Series | LDE |
| Dielectric | Metallized PEN Stacked |
| Style | SMD Chip |
| Features | Automotive Grade |
| RoHS | Yes |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Component Weight | 0.175 g |
| Shelf Life | 104 Weeks |
| MSL | 3 |

Specifications

| | |
|-----------------------|------------|
| Capacitance | 3300 pF |
| Capacitance Tolerance | 5% |
| Voltage AC | 40 VAC |
| Voltage DC | 50 VDC |
| Temperature Range | -55/+125°C |
| Rated Temperature | 125°C |
| Dissipation Factor | 0.8% 1kHz |
| Insulation Resistance | 1 GOhms |
| Max dV/dt | 100 V/us |